

# WELLCOMP TECHNOLOGY CO., LTD

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## APPROVAL SHEET

<b>Model Name</b>	<b>Metal Strip Current Sensing Resistor</b>
<b>Part Number</b>	<b>WMCSE Series</b>
<b>Customer Name</b>	
<b>Customer P/N</b>	
<b>Issued Date</b>	

Customer		Maker		
Approved	Checked	Inspector	Checked	Prepared



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## Metal Strip Current Sensing Resistor

### Features

- ◆ Ultra Low sensing resistance
- ◆ Chip size: 0402~ 1206
- ◆ Lead free, RoHS compliant for global applications and halogen free

### Application

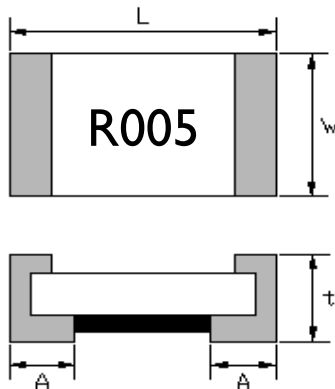
- ◆ Switching Power Supply
- ◆ Voltage Regulation Module
- ◆ DC-DC Converter, Adaptor, Battery Pack, Charger
- ◆ Pad & Cell Phone
- ◆ Power management Applications

### Part Numbering System

**WMCSE 1206 R010 F C I A**  
 (1) (2) (3) (4) (5) (6) (7)

- (1) Series Code
- (2) Size (EIA): Length x Width
- (3) Resistance: R002=2mΩ, R010=10mΩ
- (4) Tolerance: F=+/-1%, G=+/-2%, J=+/-5%
- (5) Power Rating: X=1/8W, A=1/4W, S=1/2W, C=1W, D=1.5W, E=2W
- (6) Packaging: T- Embossed paper tape, 7" reel  
 E-Embossed plastic tape, 7" reel
- (7) Factory Code, A=TWN Factory

### Dimension



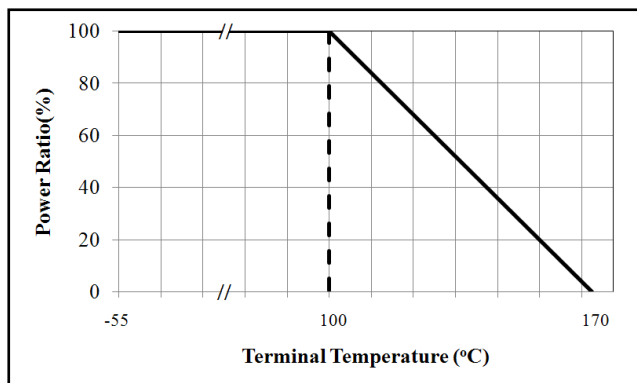
Type (inch size)	Resistance Range(mΩ)	Dimensions(mm)			
		L	W	t	A
MCSE0402	8<R<50	1.00±0.10	0.55±0.1	0.45±0.10	0.25±0.10
MCSE0402	3<R<7	1.00±0.10	0.55±0.1	0.45±0.10	0.35±0.10
MCSE0603	5<R<30	1.60±0.10	0.80±0.1	0.55±0.15	0.30±0.20
MCSE0805	5<R<30	2.00±0.20	1.30±0.15	0.70±0.15	0.45±0.20
MCSE0805	2<R<4	2.10±0.20	1.30±0.15	0.70±0.15	0.45±0.20
MCSE1206	3<R<180	3.10±0.20	1.55±0.20	0.8±0.15	0.55±0.20

\*Remark: 0402 has no marking, 0603 marking shows two digits for resistance

### Electrical Specification

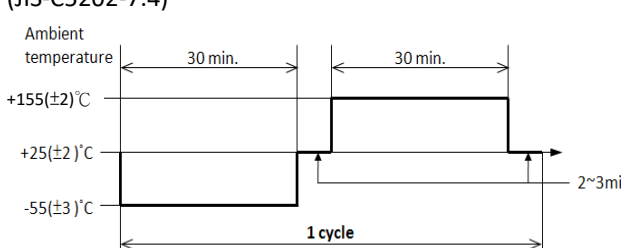
Item	Power Rating	Resistance Range(mΩ)	Operation Temp. Range	TCR (PPM/°C)
MCSE0402	1/8W	$8 \leq R \leq 50$	-55~+170°C	±100
MCSE0402	1/8W	$3 \leq R \leq 7$		±150
MCSE0603	1/4W	$10 \leq R \leq 30$		±75
MCSE0603	1/4W	$5 \leq R \leq 9$		±150
MCSE0805	1/2W	$10 < R \leq 30$		±50
MCSE0805	1/2W	$5 \leq R \leq 10$		±100
MCSE0805	1/2W	$2 \leq R \leq 4$		±100
MCSE1206	1/2W	$100 \leq R \leq 180$		±50
MCSE1206	1W	$10 < R \leq 50$		±50
MCSE1206	1W	$3 \leq R \leq 10$		±100

### Derating Curve



### Performances

#### Environmental Performance

No.	Item	Test Condition	Specification
1	Short Time Overload	5 times rated power for 5 sec. (JIS-C5202-5.5)	$\Delta R: \pm(1\%+0.0005\Omega)$
2	Temperature Coefficient of Resistance (T.C.R.)	+25°C /+125°C. (JIS-C5202-5.2) $TCR \text{ (ppm/}^\circ\text{C)} = \frac{\Delta R}{R \times \Delta t} \times 10^6$	Refer to electrical specification.
3	Damp Heat with Load	The specimens shall be placed in a chamber and subjected to a relative humidity of 90~95% percent and a temperature of 40° ±2°C for the period of 1000 hr with applying rated power 1.5 hours ON and 0.5 hour OFF. (MIL-STD-202, Method 103)	$\Delta R: \pm(1\%+0.0005\Omega)$
4	High Temperature Exposure	The chip (mounted on board) is exposed in the heat chamber 125±3°C for 1000 hrs. (JIS-C5202-7.2)	$\Delta R: \pm(1\%+0.0005\Omega)$
5	Load Life	Apply rated power at 70±2°C for 1000 hours with 1.5 hours ON and 0.5 hour OFF. (JIS-C5202-7.10)	$\Delta R: \pm(1\%+0.0005\Omega)$
6	Rapid change of temperature	The chip (mounted on board) is exposed, -55±3°C (30min.)/+155±2°C (30min.) for 5 cycles. The following conditions as the following figure. (JIS-C5202-7.4) 	$\Delta R: \pm(1\%+0.0005\Omega)$

## Metal Strip Current Sensing Resistor

### Function Performance

No.	Item	Test Condition	Specification
1	Bending Strength	<p>Mount the chip to test substrate. Apply pressure in direction of arrow unit band width reaches 2mm(+0.2/-0mm) illustrated in the figure below and hold for 10±1 sec. (JIS-C5202-6.1)</p>	$\Delta R: \pm(1\%+0.0005\Omega)$
2	Solvent Resistance	<p>The chip is completed immersion of the specimens in the isopropyl alcohol for 3 (+5, -0) min. at 25°C ±5°C. ((MIL-STD-202, Method 215)</p>	Verify marking permanency. (Nor required for laser etched parts or parts with no marking)
3	Resistance to solder Heat	<p>The specimen chip shall be immersed into the flux specified in the solder bath 260±5°C for 10±1 sec. (MIL-STD-202, Method 210)</p>	$\Delta R: \pm(1\%+0.0005\Omega)$
4	Solderability	<p>The specimen chip shall be immersed into the flux specified in the solder bath 235±5°C for 2±0.5 sec. It shall be immersed to a point 10mm from its root. (Sn96.5/Ag3.0/Cu0.5) (JIS-C5 202-6.11)</p>	Solder shall be covered 95% or more of the electrode area.

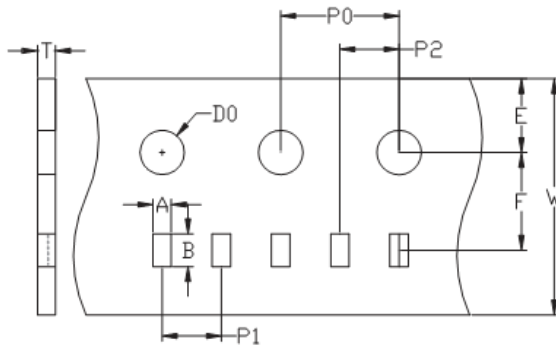
#### Remark:

- 0.5 W with total solder pad trace size of 100 mm<sup>2</sup>. The surface temperature of component should below 100°C.
- 1.0 W with total solder pad trace size of 100 mm<sup>2</sup>. The surface temperature of component should below 100°C.

## Metal Strip Current Sensing Resistor

### Tape Packaging Specifications

#### ◆Paper Tape Specifications



Unit:mm

Type	Carrier Dimensions									
	A	B	E	F	W	P0	P1	P2	D0	T
0402	0.7±0.05	1.2±0.05	1.75±0.1	3.5±0.05	8.0±0.2	4.0±0.1	2.0±0.1	2.0±0.05	1.55±0.05	0.6±0.1
0603	1.1±0.1	1.9±0.1	1.75±0.1	3.5±0.05	8.0±0.2	4.0±0.1	4.0±0.1	2.0±0.05	1.55±0.05	0.70±0.1
0805	1.6±0.1	2.4±0.1	1.75±0.1	3.5±0.05	8.0±0.2	4.0±0.1	4.0±0.1	2.0±0.05	1.55±0.05	0.97±0.1
1206	2.0±0.1	3.6±0.1	1.75±0.1	3.5±0.05	8.0±0.2	4.0±0.1	4.0±0.1	2.0±0.05	1.55±0.05	0.97±0.1

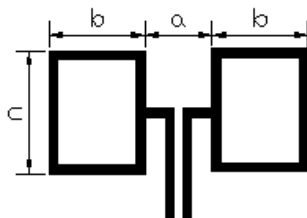
### Packaging

Size EIA (EIAJ)	0402	0603/0805/1206
Standard Packing Quantity (pcs /reel)	10,000	5,000

### Storage Conditions

Temperature : 5~35°C, Humidity : 40~75%

### Recommended Solder Pad Layout



Type		Pad Layout Dimension (mm)		
		a	b	c
0402	8mR~50mR	0.50	0.50	0.60
0402	3mR~7mR	0.30	0.60	0.60
0603	10mR~30mR	0.90	0.70	1.00
0603	5mR~9mR	0.6	0.9	1.00
0805	5mR~30mR	1.20	1.20	1.40
0805	2mR~4mR	0.8	1.20	1.40
1206		2.20	1.30	1.80

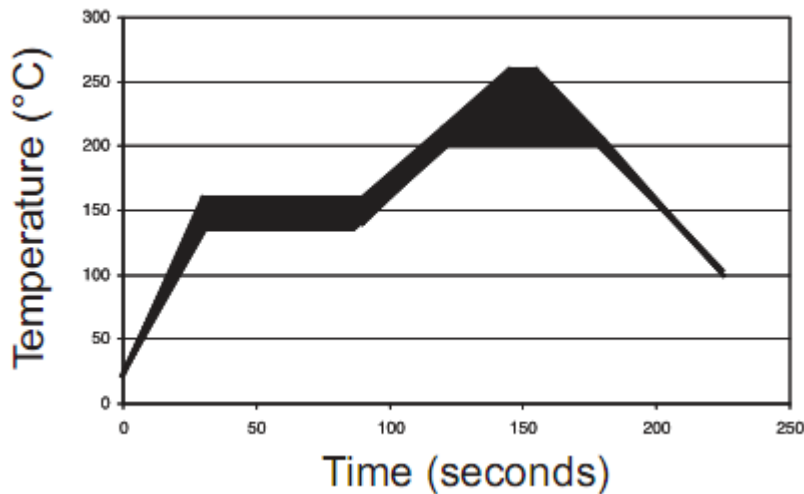
Recommend to use the steel plate which thickness > 100μm to avoid the solder height insufficient

●All Specifications are subject to change without notice.

## Metal Strip Current Sensing Resistor

### Soldering Recommendations

- ◆ Peak reflow temperatures and durations :
  - IR Reflow Peak = 260°C max for 10 sec
  - Wave Solder = 260°C max for 10 sec
- ◆ Compatible with lead and lead-free solder reflow processes
- ◆ Recommended IR Reflow Profile :



### ECN

Engineering Change Notice : The customer will be informed with ECN if there is significant modification on the characteristics and materials described in Approval Sheet.

### Disclaimer

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# WMCSE Series

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## Metal Strip Current Sensing Resistor

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